

# XN04381 (XN4381)

Silicon NPN epitaxial planer transistor (Tr1)  
 Silicon PNP epitaxial planer transistor (Tr2)

For switching/digital circuits

### ■ Features

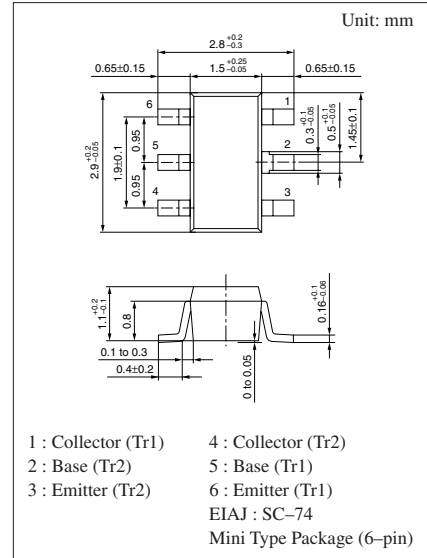
- Two elements incorporated into one package.  
 (Transistors with built-in resistor)
- Reduction of the mounting area and assembly cost by one half.

### ■ Basic Part Number of Element

- UNR1213(UN1213) + UNR1122(UN1122)

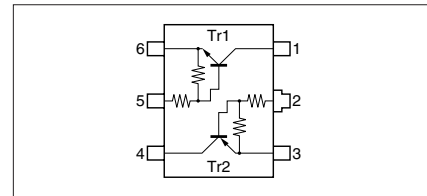
### ■ Absolute Maximum Ratings (Ta=25°C)

	Parameter	Symbol	Ratings	Unit
Tr1	Collector to base voltage	$V_{CBO}$	50	V
	Collector to emitter voltage	$V_{CEO}$	50	V
	Collector current	$I_C$	100	mA
Tr2	Collector to base voltage	$V_{CBO}$	-50	V
	Collector to emitter voltage	$V_{CEO}$	-50	V
	Collector current	$I_C$	-500	mA
Overall	Total power dissipation	$P_T$	300	mW
	Junction temperature	$T_j$	150	°C
	Storage temperature	$T_{stg}$	-55 to +150	°C



Marking Symbol: CW

Internal Connection



Note.) The Part number in the Parenthesis shows conventional part number.

### ■ Electrical Characteristics (T<sub>a</sub>=25°C)

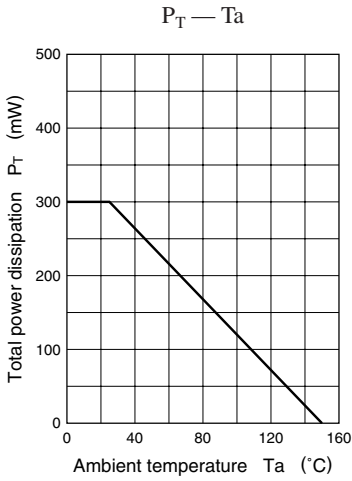
#### ● Tr1

Parameter	Symbol	Conditions	min	typ	max	Unit
Collector to base voltage	V <sub>CBO</sub>	I <sub>C</sub> = 10μA, I <sub>E</sub> = 0	50			V
Collector to emitter voltage	V <sub>CEO</sub>	I <sub>C</sub> = 2mA, I <sub>B</sub> = 0	50			V
Collector cutoff current	I <sub>CBO</sub>	V <sub>CB</sub> = 50V, I <sub>E</sub> = 0			0.1	μA
	I <sub>CEO</sub>	V <sub>CE</sub> = 50V, I <sub>B</sub> = 0			0.5	μA
Emitter cutoff current	I <sub>EBO</sub>	V <sub>EB</sub> = 6V, I <sub>C</sub> = 0			0.1	mA
Forward current transfer ratio	h <sub>FE</sub>	V <sub>CE</sub> = 10V, I <sub>C</sub> = 5mA	80			
Collector to emitter saturation voltage	V <sub>CE(sat)</sub>	I <sub>C</sub> = 10mA, I <sub>B</sub> = 0.3mA			0.25	V
Output voltage high level	V <sub>OH</sub>	V <sub>CC</sub> = 5V, V <sub>B</sub> = 0.5V, R <sub>L</sub> = 1kΩ	4.9			V
Output voltage low level	V <sub>OL</sub>	V <sub>CC</sub> = 5V, V <sub>B</sub> = 3.5V, R <sub>L</sub> = 1kΩ			0.2	V
Transition frequency	f <sub>T</sub>	V <sub>CB</sub> = 10V, I <sub>E</sub> = -2mA, f = 200MHz		150		MHz
Input resistance	R <sub>1</sub>		-30%	47	+30%	kΩ
Resistance ratio	R <sub>1</sub> /R <sub>2</sub>		0.8	1.0	1.2	

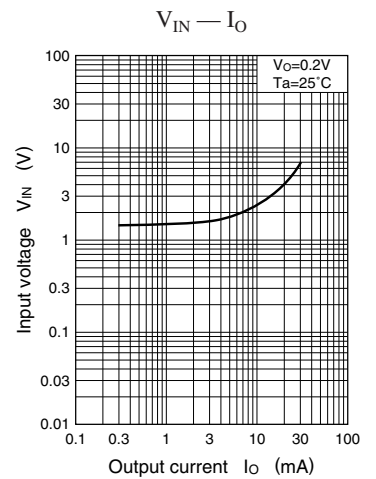
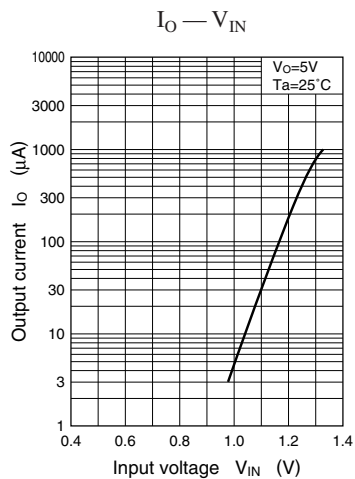
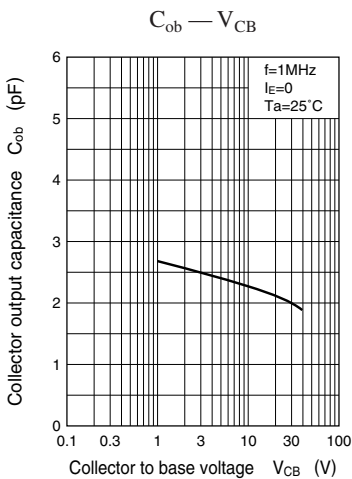
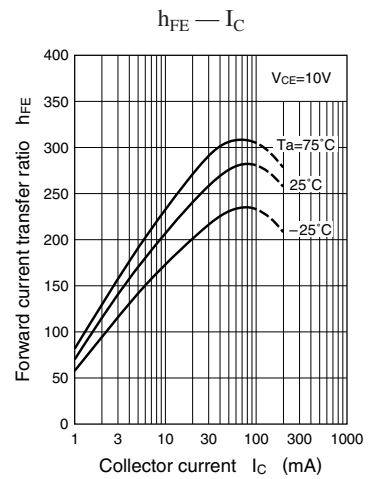
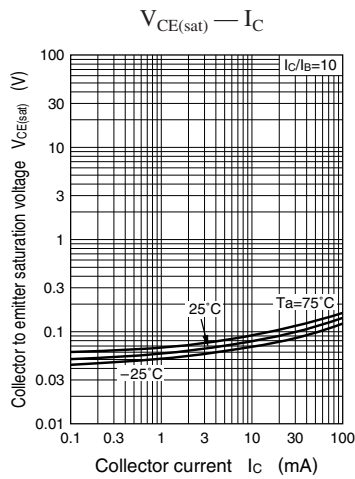
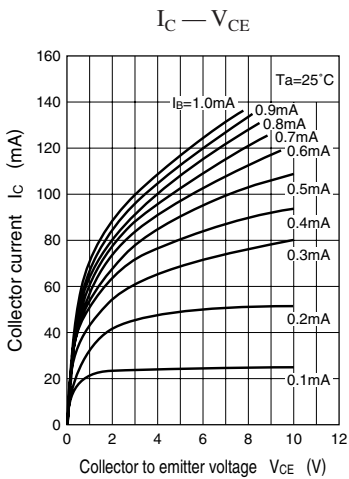
#### ● Tr2

Parameter	Symbol	Conditions	min	typ	max	Unit
Collector to base voltage	V <sub>CBO</sub>	I <sub>C</sub> = -10μA, I <sub>E</sub> = 0	-50			V
Collector to emitter voltage	V <sub>CEO</sub>	I <sub>C</sub> = -2mA, I <sub>B</sub> = 0	-50			V
Collector cutoff current	I <sub>CBO</sub>	V <sub>CB</sub> = -50V, I <sub>E</sub> = 0			-1	μA
	I <sub>CEO</sub>	V <sub>CE</sub> = -50V, I <sub>B</sub> = 0			-1	μA
Emitter cutoff current	I <sub>EBO</sub>	V <sub>EB</sub> = -6V, I <sub>C</sub> = 0			-2	mA
Forward current transfer ratio	h <sub>FE</sub>	V <sub>CE</sub> = -10V, I <sub>C</sub> = -100mA	50			
Collector to emitter saturation voltage	V <sub>CE(sat)</sub>	I <sub>C</sub> = -100mA, I <sub>B</sub> = -5mA			-0.25	V
Output voltage high level	V <sub>OH</sub>	V <sub>CC</sub> = -5V, V <sub>B</sub> = -0.5V, R <sub>L</sub> = 500Ω	-4.9			V
Output voltage low level	V <sub>OL</sub>	V <sub>CC</sub> = -5V, V <sub>B</sub> = -3.5V, R <sub>L</sub> = 500Ω			-0.2	V
Transition frequency	f <sub>T</sub>	V <sub>CB</sub> = -10V, I <sub>E</sub> = 50mA, f = 200MHz		200		MHz
Input resistance	R <sub>1</sub>		-30%	4.7	+30%	kΩ
Resistance ratio	R <sub>1</sub> /R <sub>2</sub>		0.8	1.0	1.2	

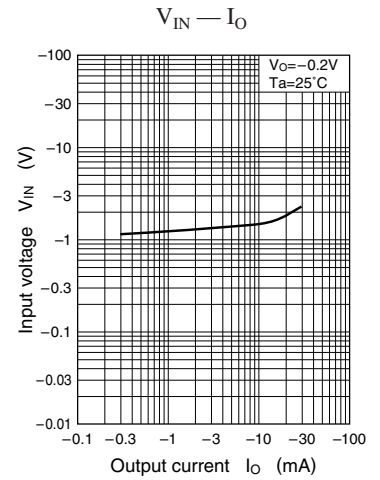
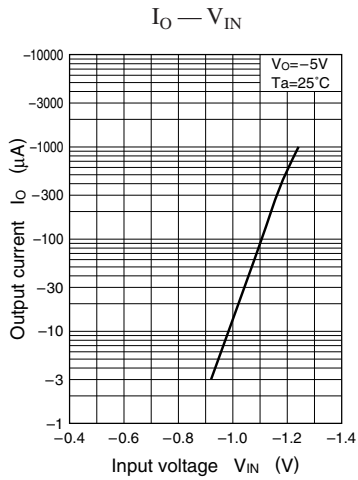
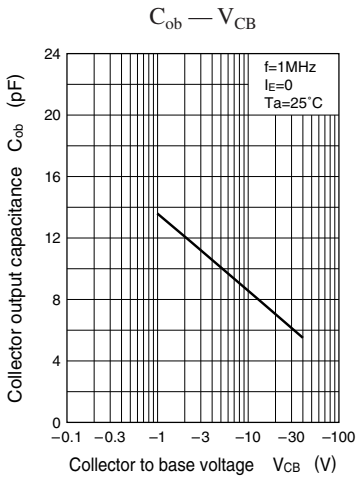
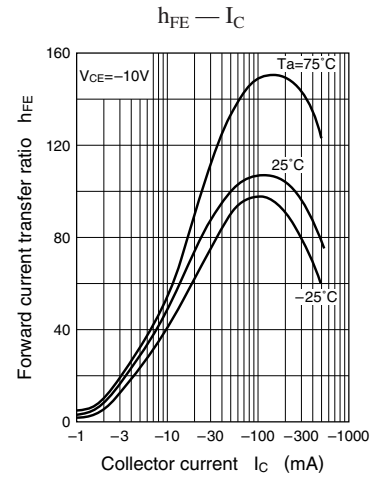
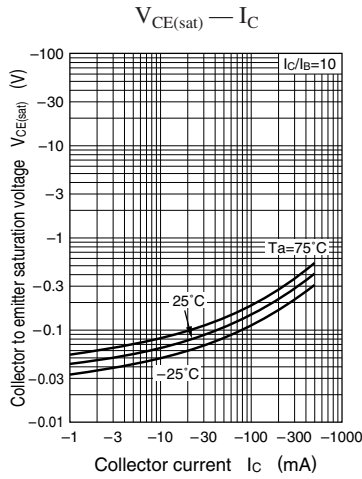
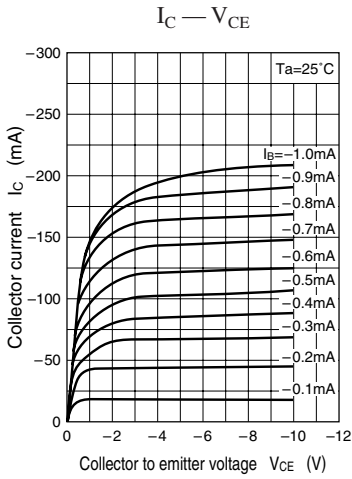
Common characteristics chart



Characteristics charts of Tr1



Characteristics charts of Tr2



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